# **MOSFET** – Power, Single, P-Channel, SC-70

-8.0 V, -1.4 A

# **NTS2101P**

#### **Features**

- Leading Trench Technology for Low R<sub>DS(on)</sub> Extending Battery Life
- -1.8 V Rated for Low Voltage Gate Drive
- SC-70 Surface Mount for Small Footprint (2 x 2 mm)
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

### **Applications**

- High Side Load Switch
- Charging Circuit
- Single Cell Battery Applications such as Cell Phones, Digital Cameras, PDAs, etc.

# **MAXIMUM RATINGS** (T<sub>J</sub> = 25°C unless otherwise stated)

| Parame  | Symbol                               | Value                 | Units          |      |   |
|---|--------------------------------------|-----------------------|----------------|------|---|
| Drain-to-Source Voltage                             | V <sub>DSS</sub>                     | -8.0                  | V              |      |   |
| Gate-to-Source Voltage                              |                                      |                       | $V_{GS}$       | ±8.0 | ٧ |
|   |                                      | T <sub>A</sub> = 25°C | I <sub>D</sub> | -1.4 | Α |
| Current (Note 1)                                    | State                                | T <sub>A</sub> = 70°C |                | -1.1 |   |
| $t \le 5 s$ $T_A = 2$                               |                                      |                       |                | -1.5 | Α |
| Power Dissipation<br>(Note 1)                       | Steady State T <sub>A</sub> = 25°C   |                       | P <sub>D</sub> | 0.29 | W |
| t ≤ 5 s   |                                      |                       |                | 0.33 | W |
| Pulsed Drain Current                                | I <sub>DM</sub>                      | -3.0                  | Α              |      |   |
| Operating Junction and St                           | T <sub>J</sub> ,<br>T <sub>STG</sub> | –55 to<br>150         | ô              |      |   |
| Source Current (Body Dio                            | I <sub>S</sub>                       | -0.46                 | Α              |      |   |
| Lead Temperature for Solo<br>(1/8" from case for 10 | TL                                   | 260                   | °C             |      |   |

#### THERMAL RESISTANCE RATINGS

| Parameter                                   | Symbol          | Max | Units |
|---|-----------------|-----|-------|
| Junction-to-Ambient - Steady State (Note 1) | $R_{\theta JA}$ | 430 | °C/W  |
| Junction-to-Ambient - t ≤ 5 s (Note 1)      | $R_{\theta JA}$ | 375 |       |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Surface-mounted on FR4 board using 1 in sq pad size (Cu area = 1.127 in sq [1 oz] including traces).

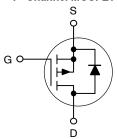


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| V <sub>(BR)DSS</sub> | R <sub>DS(on)</sub> Typ | I <sub>D</sub> Max |
|----------------------|-------------------------|--------------------|
|                      | 65 m $\Omega$ @ –4.5 V  |                    |
| -8.0 V               | 78 m $\Omega$ @ –2.5 V  | -1.4 A             |
|                      | 117 mΩ @ –1.8 V         |                    |

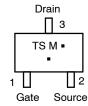
#### P-Channel MOSFET



# MARKING DIAGRAM & PIN ASSIGNMENT



SC-70/SOT-323 CASE 419 STYLE 8



TS = Device Code

M = Date Code\*

Pb-Free Package

(Note: Microdot may be in either location)

\*Date Code orientation may vary depending upon manufacturing location.

## **ORDERING INFORMATION**

| Device      | Package              | Shipping <sup>†</sup> |
|-------------|----------------------|-----------------------|
| NTS2101PT1  | SOT-323              | 3000/Tape & Reel      |
| NTS2101PT1G | SOT-323<br>(Pb-Free) | 3000/Tape & Reel      |

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

# NTS2101P

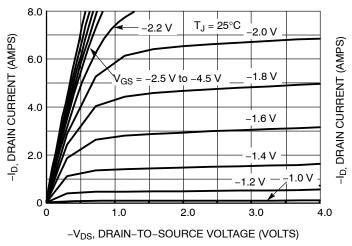
# **ELECTRICAL CHARACTERISTICS** (T<sub>.I</sub> = 25°C unless otherwise stated)

| Parameter  | Symbol                               | Test Condition  |                             | Min   | Тур   | Max  | Unit  |
|--|--------------------------------------|---|-----------------------------|-------|-------|------|-------|
| OFF CHARACTERISTICS  |                                      |   |                             |       |       |      |       |
| Drain-to-Source Breakdown Voltage                            | V <sub>(BR)DSS</sub>                 | $V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$                            |                             | -8.0  | -20   |      | V     |
| Drain-to-Source Breakdown Voltage<br>Temperature Coefficient | V <sub>(BR)DSS</sub> /T <sub>J</sub> |   |                             |       | -10   |      | mV/°C |
| Zero Gate Voltage Drain Current                              | I <sub>DSS</sub>                     | $V_{GS} = 0 \text{ V},$<br>$V_{DS} = -6.4 \text{ V}$                      | T <sub>J</sub> = 25°C       |       |       | -1.0 | μΑ    |
|  |                                      | VDS = -0.4 V  | $T_J = 70^{\circ}C$         |       |       | -5.0 |       |
| Gate-to-Source Leakage Current                               | I <sub>GSS</sub>                     | $V_{DS} = 0 V, V_{G}$   | $_{iS} = \pm 8.0 \text{ V}$ |       |       | ±100 | nA    |
| ON CHARACTERISTICS (Note 2)                                  |                                      |   |                             |       |       |      |       |
| Gate Threshold Voltage                                       | V <sub>GS(TH)</sub>                  | $V_{GS} = V_{DS}, I_D$  | = -250 μA                   | -0.45 | -0.7  | -1.0 | V     |
| Negative Threshold<br>Temperature Coefficient                | V <sub>GS(TH)</sub> /T <sub>J</sub>  |   |                             |       | 2.6   |      | mV/°C |
| Drain-to-Source On Resistance                                | R <sub>DS(on)</sub>                  | $V_{GS} = -4.5 \text{ V},$  | I <sub>D</sub> = -1.0 A     |       | 65    | 100  | mΩ    |
|  |                                      | $V_{GS} = -2.5 V$ ,   | I <sub>D</sub> = -0.5 A     |       | 78    | 140  | 7     |
|  |                                      | $V_{GS} = -1.8 \text{ V},$  | I <sub>D</sub> = -0.3 A     |       | 117   | 210  | 7     |
| CHARGES AND CAPACITANCES                                     |                                      |   |                             |       |       |      |       |
| Input Capacitance  | C <sub>ISS</sub>                     | $V_{GS} = 0 \text{ V, f} = 1.0 \text{ MHz,}$<br>$V_{DS} = -8.0 \text{ V}$ |                             |       | 640   |      | pF    |
| Output Capacitance   | C <sub>OSS</sub>                     |   |                             |       | 120   |      |       |
| Reverse Transfer Capacitance                                 | C <sub>RSS</sub>                     |   | ŀ                           |       | 82    |      | 7     |
| Total Gate Charge  | Q <sub>G(TOT)</sub>                  | V <sub>GS</sub> = -5.0 V, V <sub>DD</sub> = -5.0 V,                       |                             |       | 6.4   |      | nC    |
| Threshold Gate Charge  | Q <sub>G(TH)</sub>                   | I <sub>D</sub> = -1   | .0 A                        |       | 0.7   |      | 1     |
| Gate-to-Source Charge  | $Q_{GS}$                             |   |                             |       | 1.0   |      |       |
| Gate-to-Drain Charge   | $Q_GD$                               |   |                             |       | 1.5   |      |       |
| SWITCHING CHARACTERISTICS (No                                | ote 3)                               |   |                             |       |       |      |       |
| Turn-On Delay Time   | t <sub>d(ON)</sub>                   | V <sub>GS</sub> = -4.5 V, V   | <sub>DD</sub> = -4.0 V,     |       | 6.2   |      | ns    |
| Rise Time  | t <sub>r</sub>                       | $I_D = -1.0 \text{ A, F}$   | $I_{G} = 0.2 \Omega$        |       | 15    |      |       |
| Turn-Off Delay Time  | t <sub>d(OFF)</sub>                  |   |                             |       | 26    |      |       |
| Fall Time  | t <sub>f</sub>                       |   |                             |       | 18    |      |       |
| DRAIN-SOURCE DIODE CHARACTE                                  | RISTICS                              |   |                             |       |       |      |       |
| Forward Diode Voltage  | $V_{SD}$                             | $V_{GS} = 0 \text{ V},$ $I_{S} = -0.3 \text{ A}$                          | T <sub>J</sub> = 25°C       |       | -0.62 | -1.2 | V     |
|  |                                      | IS = -0.3 A   | T <sub>J</sub> = 125°C      |       | -0.51 |      |       |
| Reverse Recovery Time  | t <sub>RR</sub>                      | $V_{GS} = 0 \text{ V, } dI_{SD}/c$ $I_{S} = -1$                           |                             |       | 23.4  |      | ns    |
| Charge Time  | T <sub>a</sub>                       | 1S = -1   | .0 A                        |       | 7.7   |      |       |
| Discharge Time   | T <sub>b</sub>                       |   |                             |       | 15.7  |      |       |
| Reverse Recovery Charge                                      | $Q_{RR}$                             |   |                             |       | 9.5   |      | nC    |

Pulse Test: pulse width ≤ 300 μs, duty cycle ≤ 2%.
 Switching characteristics are independent of operating junction temperatures.

#### NTS2101P

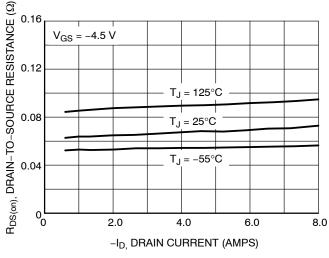
#### TYPICAL ELECTRICAL CHARACTERISTICS



 $V_{DS} \ge -10 \text{ V}$ 6.0 4.0 2.0 T<sub>J</sub> = 125°C  $T_J = 25^{\circ}C$  $T_J = -55^{\circ}C$ 0 0.4 1.2 2.0 8.0 1.6 2.4 2.8 -V<sub>GS</sub>, GATE-TO-SOURCE VOLTAGE (VOLTS)

Figure 1. On-Region Characteristics

Figure 2. Transfer Characteristics



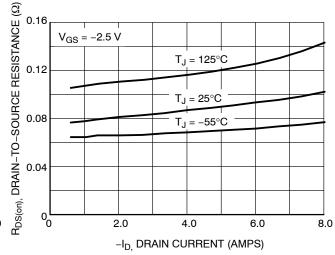
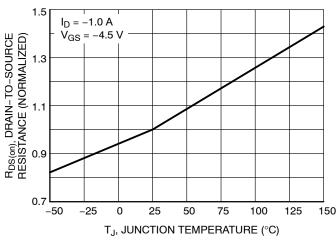


Figure 3. On–Resistance vs. Drain Current and Temperature

Figure 4. On–Resistance vs. Drain Current and Temperature



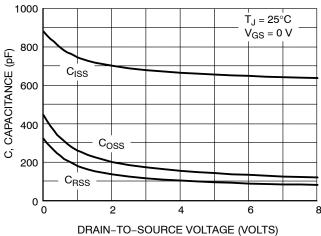


Figure 5. On–Resistance Variation with Temperature

Figure 6. Capacitance Variation

# NTS2101P

# TYPICAL ELECTRICAL CHARACTERISTICS

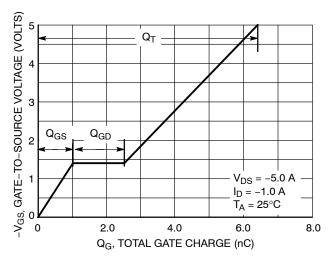


Figure 7. Gate-to-Source and Drain-to-Source Voltage vs. Total Gate Charge

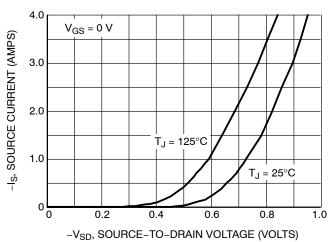


Figure 8. Diode Forward Voltage vs. Current





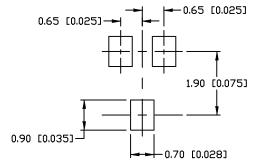
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**DATE 07 OCT 2021** 

#### NOTES:

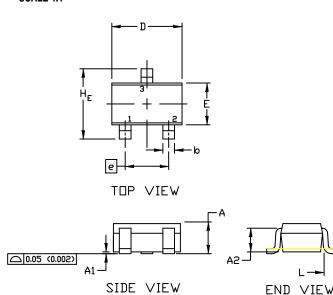
- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: INCH

|     | MILLIMETERS |          |      |       | INCHES   |       |
|-----|-------------|----------|------|-------|----------|-------|
| DIM | MIN.        | N□M.     | MAX. | MIN.  | N□M.     | MAX.  |
| Α   | 0.80        | 0.90     | 1.00 | 0.032 | 0.035    | 0.040 |
| A1  | 0.00        | 0.05     | 0.10 | 0.000 | 0.002    | 0.004 |
| A2  |             | 0.70 REF |      |       | 0.028 BS | C     |
| b   | 0.30        | 0.35     | 0.40 | 0.012 | 0.014    | 0.016 |
| С   | 0.10        | 0.18     | 0.25 | 0.004 | 0.007    | 0.010 |
| D   | 1.80        | 2.10     | 2.20 | 0.071 | 0.083    | 0.087 |
| Ε   | 1.15        | 1.24     | 1.35 | 0.045 | 0.049    | 0.053 |
| e   | 1.20        | 1.30     | 1.40 | 0.047 | 0.051    | 0.055 |
| e1  | 0.65 BSC    |          |      |       | 0.026 BS | C     |
| L   | 0.20        | 0.38     | 0.56 | 0.008 | 0.015    | 0.022 |
| HE  | 2.00        | 2.10     | 2.40 | 0.079 | 0.083    | 0.095 |
|     |             |          |      |       |          |       |



For additional information on our Pb-Free strategy and soldering details, please download the IIN Semiconductor Soldering and Mounting Techniques Reference Manual, SILDERRM/D.

SOLDERING FOOTPRINT



# GENERIC MARKING DIAGRAM



XX = Specific Device Code

M = Date Code

■ = Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

| STYLE 1:<br>CANCELLED | STYLE 2:<br>PIN 1. ANODE<br>2. N.C.<br>3. CATHODE | STYLE 3:<br>PIN 1. BASE<br>2. EMITTER<br>3. COLLECTOR | STYLE 4:<br>PIN 1. CATHODE<br>2. CATHODE<br>3. ANODE | STYLE 5:<br>PIN 1. ANODE<br>2. ANODE<br>3. CATHODE |                |
|-----------------------|---|---|--|--|----------------|
| STYLE 6:              | STYLE 7:  | STYLE 8:  | STYLE 9:   | STYLE 10:  | STYLE 11:      |
| PIN 1. EMITTER        | PIN 1. BASE                                       | PIN 1. GATE   | PIN 1. ANODE   | PIN 1. CATHODE                                     | PIN 1. CATHODE |
| 2. BASE               | 2. EMITTER  | 2. SOURCE   | 2. CATHODE   | 2. ANODE   | 2. CATHODE     |
| 3. COLLECTOR          | 3. COLLECTOR                                      | 3. DRAIN  | 3. CATHODE-ANODE                                     | 3. ANODE-CATHODE                                   | 3. CATHODE     |

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| DESCRIPTION:     | SC-70 (SOT-323) |   | PAGE 1 OF 1 |  |

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